

STPS5L25

Datasheet – production data

Low drop power Schottky rectifier

A3 + $\frac{2}{4}$ (TAB) 1 $\frac{2}{3}$ $\frac{1}{NC}$ $\frac{2}{3}$ $\frac{2}{3}$ DPAK

Description

Single Schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in DPAK, this device is intended for use as a rectifier at the secondary of 3.3 V SMPS units.

Symbol	Value			
I _{F(AV)}	5 A			
V _{RRM}	25 V			
T _{j (max)}	150 °C			
V _{F(typ)}	0.31 V			

Table 1. Device summary

Features

- Very low forward voltage drop for less power dissipation and reduced heatsink
- Optimized conduction/reverse losses trade-off which means the highest efficiency in the applications
- High power surface mount miniature package
- Avalanche specification
- ECOPACK[®]2 compliant component for DPAK on demand

This is information on a product in full production.

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C unless otherwise stated)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	25	V	
I _{F(RMS)}	Forward rms current	7	А	
I _{F(AV)}	Average forward current, square wave $T_c =$	5	А	
I _{FSM}	Surge non repetitive forward current $t_p =$	75	А	
P _{ARM}	Repetitive peak avalanche power $t_p =$	215	W	
T _{stg}	Storage temperature range	-65 to + 150	°C	
Тj	Maximum operating junction temperature ⁽¹⁾	150	°C	
dPtot	1			

1. $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-	-	350	μA
'R ''		T _j = 125 °C		-	55	115	mA
V _F ⁽²⁾	Forward voltage drop	T _j = 25 °C	I _F = 5 A	-	-	0.47	V
		T _j = 125 °C		-	0.31	0.35	
		T _j = 25 °C	I _F = 10 A	-	-	0.59	
		T _j = 125 °C		-	0.41	0.50	

Table 4. Static electrical characteristics

1. Pulse test: $t_p = 380 \text{ ms}, \delta < 2\%$

2. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.2 \text{ x } I_{F(AV)} + 0.03 I_{F}^{2}(RMS)$



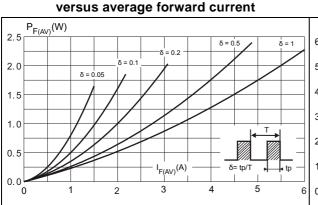


Figure 1. Average forward power dissipation

Figure 2. Average forward current versus ambient temperature (δ = 0.5)

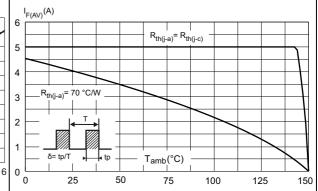
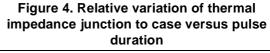


Figure 3. Normalized avalanche power derating versus pulse duration at T_i = 125 °C



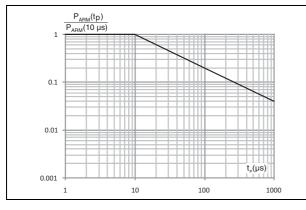


Figure 5. Reverse leakage current versus reverse voltage applied (typical values)

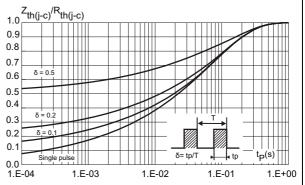


Figure 6. Junction capacitance versus reverse voltage applied (typical values)

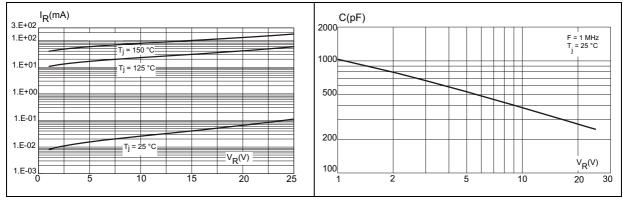
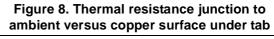
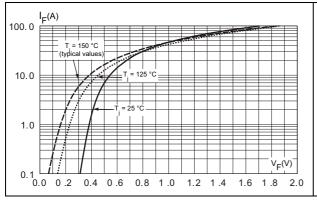
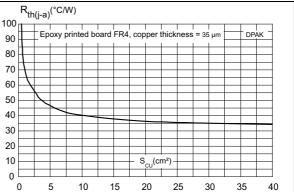


Figure 7. Forward voltage drop versus forward current (maximum values)







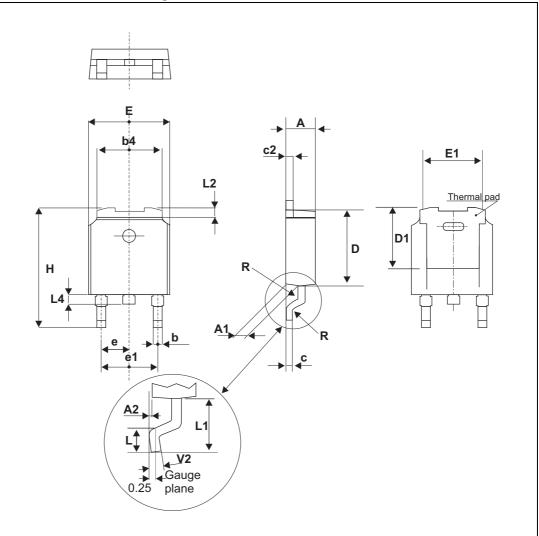


2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.





Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

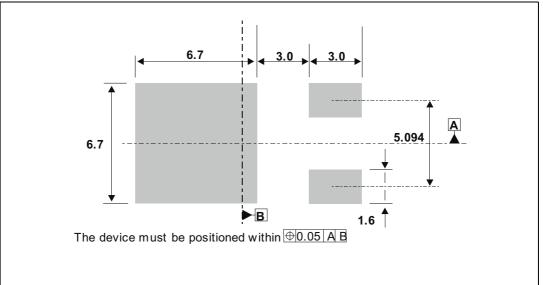


DocID3626 Rev 7

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	2.18		2.40	0.085		0.094	
A1	0.90		1.1	0.035		0.043	
A2	0.03		0.23	0.001		0.01	
b	0.64		0.90	0.025		0.035	
b4	4.95		5.46	0.195		0.215	
С	0.46		0.61	0.018		0.024	
c2	0.46		0.60	0.018		0.024	
D	5.97		6.22	0.235		0.245	
D1	5.10			0.201			
E	6.35		6.73	0.250		0.265	
E1	4.32			0.170			
e1	4.4		4.7	0.173		0.185	
Н	9.35		10.40	0.368		0.407	
L	1.0		1.78	0.039		0.070	
L2			1.27			0.05	
L4	0.6		1.02	0.024		0.040	
V2	0°		8°	0°		8°	

Table 5. DPAK dimension values

Figure 10. DPAK footprint dimensions (in mm)



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS5L25B-TR	STPS5L25B	DPAK	0.32 g	2500	Tape and reel

4 Revision history

Table 7. Document rev	vision his	torv
-----------------------	------------	------

Date	Revision	Changes
Jul-2003	5A	Previous release.
15-Apr-2008	6	Reformatted to current standard. Corrected order code in <i>Table 5</i> .
08-Jan-2015	7	Updated package information and reformatted to current standard.



IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics - All rights reserved

DocID3626 Rev 7



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: STPS5L25B-TR